NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE82H110D uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

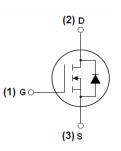
- $V_{DS} = 82V, I_{D} = 110A$ $R_{DS(ON)} < 7mΩ @ V_{GS} = 10V$ (Typ:5.9mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin assignment



TO-263-2L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE82H110D	NCE82H110D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	82	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	110	Α
Drain Current-Continuous(T _C =100°C)	I _D (100°C)	81	Α
Pulsed Drain Current	I _{DM}	350	А
Maximum Power Dissipation	P _D	200	W
Derating factor		1.33	W/°C
Single pulse avalanche energy (Note 5)	E _{AS}	950	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$



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Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	R _{θJc}	0.75	°C/W	Ī
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Electrical Characteristics (T_C=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	82	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =82V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	5.9	7.0	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	60	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	1/ 401/1/ 01/	-	6400	-	PF
Output Capacitance	Coss	V_{DS} =40V, V_{GS} =0V,	-	334	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	318	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	21	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =1 Ω	-	39	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =2.5 Ω	-	70	-	nS
Turn-Off Fall Time	t _f		-	24	-	nS
Total Gate Charge	Qg	\/ -40\/ L -20A	-	120	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=40V, I_{D}=20A,$	-	25.4	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	39.4	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =110A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	110	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	43	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	93	-	nC

Notes:

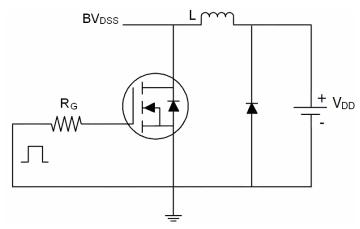
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^{\circ}$ C,VDD=40V,VG=10V,L=0.5mH,Rg=25 Ω



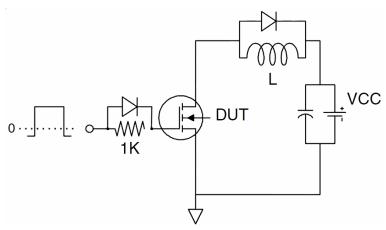
NCE82H110D

Test circuit

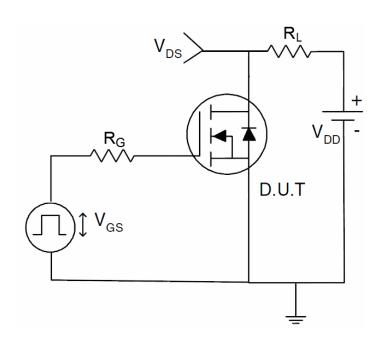
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Pb Free Product



Typical Electrical and Thermal Characteristics (Curves)

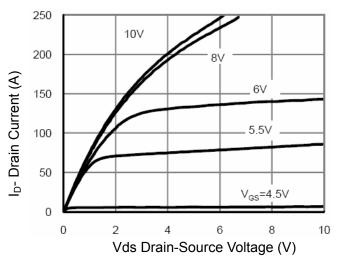


Figure 1 Output Characteristics

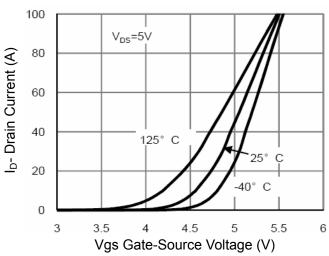


Figure 2 Transfer Characteristics

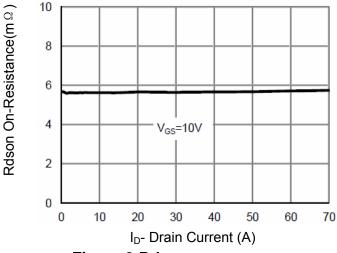


Figure 3 Rdson- Drain Current

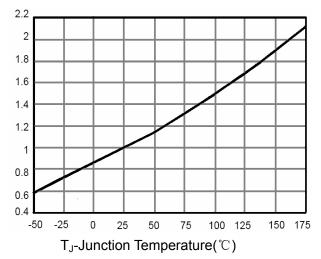
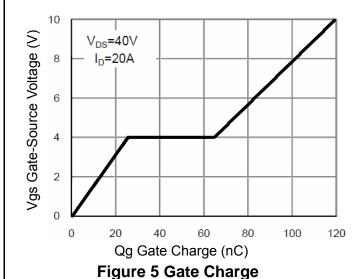


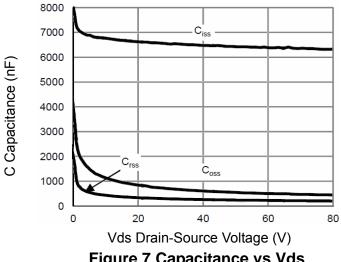
Figure 4 Rdson-JunctionTemperature



1.0E+02 € 1.0E+01 Reverse Drain Current 1.0E+00 125° C 1.0E-01 1.0E-02 1.0E-03 25° C 1.0E-04 __s 1.0E-05 0.2 0.4 1.0 1.2 Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

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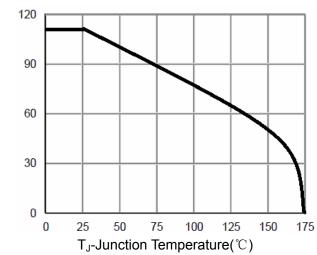
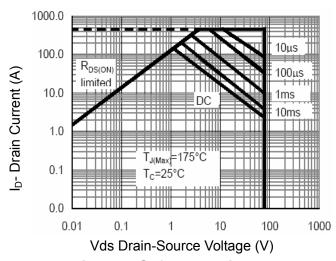


Figure 7 Capacitance vs Vds

Figure 9 Current De-rating



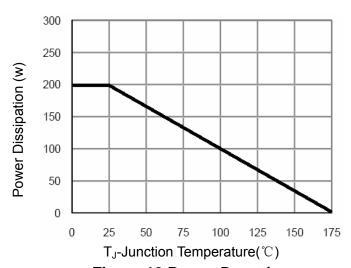
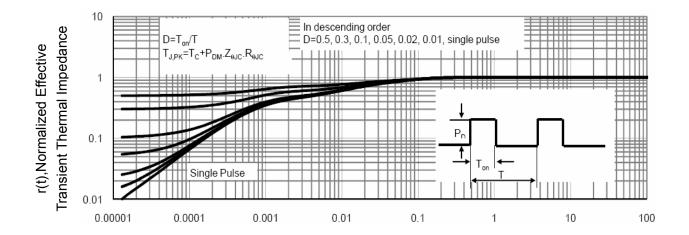


Figure 8 Safe Operation Area

Figure 10 Power De-rating



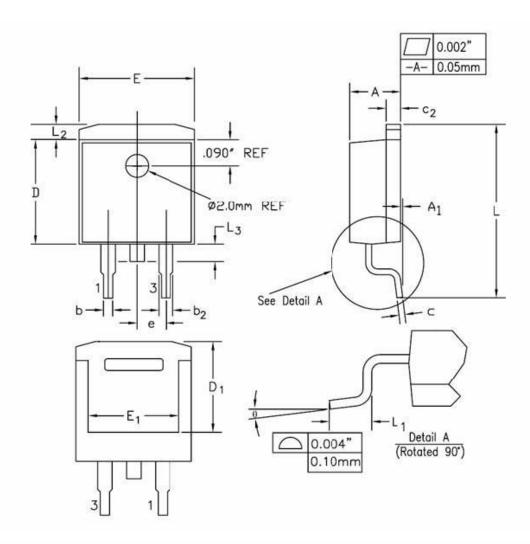
ID- Drain Current (A)

Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-263-2L Package Information



SYMBOL	INCHES		MILLIMETERS		NOTES	
STINIBOL	MIN	MAX	MIN	MAX	NOTES	
Α	0.170	0.180	4.32	4.57		
A1	-	0.010	-	0.25		
b	0.028	0.037	0.71	0.94		
b2	0.045	0.055	1.15	1.40		
С	0.018	0.024	0.46	0.61		
c2	0.048	0.055	1.22	1.40		
D	0.350	0.370	8.89	9.40		
D1	0.315	0.324	8.01	8.23		
E	0.395	0.405	10.04	10.28		
E1	0.310	0.318	7.88	8.08		
e	0.100 BSC.		2.54 BSC.			
L	0.580	0.620	14.73	15.75		
L1	0.090	0.110	2.29	2.79		
L2	0.045	0.055	1.15	1.39		
L3	0.050	0.070	1.27	1.77		
θ	0°	8°	0°	8°		



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